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anne\_cirkel@mentor.com



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soha@cs.tufts.edu



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shu@nd.edu



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rob.aitken@arm.com



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valeria@umich.edu



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ramond.rodriguez@intel.com



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danb@cadence.com



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acooprid@ford.com



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samarjit@tum.de



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mac@adapt-ip.com



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rkarri@nyu.edu



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michelle.clancy@cayennecom.com



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tiffany.sparks@arm.com



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shishpal.s.rawat@intel.com



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*MP Associates, Inc.*  
kevin@mpassociates.com



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lee@mpassociates.com

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 Cambridge, United Kingdom

**Domenic Forte**  
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*Mentor Graphics Corporation*  
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*Qualcomm Technologies, Inc.*  
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*Taiwan Semiconductor Manufacturing Co., Ltd.*  
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*Intel Corporation*  
 Santa Clara, CA

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 Cambridge, United Kingdom

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 Hsinchu, Taiwan

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*Michigan Technological Univ.*  
 Houghton, MI

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 Washington, DC

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*Mentor Graphics Corporation*  
 Marlboro, MA

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 Mountain View, CA

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*Qualcomm Technologies, Inc.*  
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 Seoul, Republic of Korea

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 Singapore, Singapore

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*Univ. of Pittsburgh*  
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**Yih-Lang Li**  
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 Hsinchu, Taiwan

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 Beijing, China

**Roman Lysecky**  
*Univ. of Arizona*  
 Tucson, AZ

**Alberto Macii**  
*Politecnico di Torino*  
 Torino, Italy

# TECHNICAL PROGRAM COMMITTEE

Enrico Macii  
*Politecnico di Torino*  
Torino, Italy

Paolo Maffezzoni  
*Politecnico di Milano*  
Milano, Italy

Ken Mai  
*Carnegie Mellon Univ.*  
Pittsburgh, PA

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United Arab Emirates

Igor Markov  
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Dortmund, Germany

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Montreal, QC, Canada

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*Univ. of Florida*  
Gainesville, FL

Jose Monteiro  
*INESC-ID, Instituto Superior Tecnico*  
Lisbon, Portugal

Onur Mutlu  
*Carnegie Mellon Univ.*  
Pittsburgh, PA

Seetharam Narasimhan  
*Intel Corporation*  
Hillsboro, OR

Vijaykrishnan Narayanan  
*Pennsylvania State Univ.*  
Univ. Park, PA

Gabriela Nicolescu  
*École Polytechnique de Montréal*  
Montreal, QC, Canada

Umit Ogras  
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Tempe, AZ

Seda Ogrençi-Memik  
*Northwestern Univ.*  
Evanston, IL

Hyunok Oh  
*Hanyang Univ.*  
Seoul, Republic of Korea

Sule Ozev  
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Tempe, AZ

Rajendran Panda  
*Oracle Corp.*  
Austin, TX

Partha Pande  
*Washington State Univ.*  
Pullman, WA

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Sudeep Pasricha  
*Colorado State Univ.*  
Fort Collins, CO

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*Cryptography Research, Inc.*  
San Francisco, CA

Frédéric Pétrot  
*TIMA Laboratory, CNRS/  
Grenoble INP/UJF*  
Grenoble, France

Linh Thi Xuan Phan  
*Univ. of Pennsylvania*  
Philadelphia, PA

Massimo Poncino  
*Politecnico di Torino*  
Torino, Italy

Miodrag Potkonjak  
*Univ. of California, Los Angeles*  
Los Angeles, CA

Marc Pouzet  
*Ecole Normale Supérieure*  
Paris, France

Qinru Qiu  
*Syracuse Univ.*  
Syracuse, NY

Gang Qu  
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Gang Quan  
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Miami, FL

Anand Raghunathan  
*Purdue Univ.*  
West Lafayette, IN

Vijay Raghunathan  
*Purdue Univ.*  
West Lafayette, IN

Binoy Ravindran  
*Virginia Polytechnic Institute  
and State Univ.*  
Blacksburg, VA

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*Univ. of Tennessee*  
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*Utah State Univ.*  
Logan, UT

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*Technische Univ. Darmstadt*  
Darmstadt, Germany

Patrick Schaumont  
*Virginia Polytechnic Institute and  
State Univ.*  
Blacksburg, VA

Gunar Schirner  
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Boston, MA

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*Univ. of Texas at Dallas*  
Richardson, TX

Zili Shao  
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Hong Kong

Weiping Shi  
*Texas A&M Univ., Mentor  
Graphics Corporation*  
College Station, TX

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and Technology*  
Rolla, MO

Youngsoo Shin  
*KAIST*  
Daejeon, Republic of Korea

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*Politecnico di Milano*  
Milano, Italy

Ozgur Sinanoglu  
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Abu Dhabi, United Arab Emirates

Satnam Singh  
*Google, Inc.*  
Mountainview, CA

Saurabh Sinha  
*ARM Ltd.*  
Austin, TX

Frank Slomka  
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Ulm, Germany

Daryl Stewart  
*ARM Ltd.*  
Cambridge, United Kingdom

Cliff Sze  
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IBM Research - Austin*  
Austin, TX

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*Karlsruhe Institute of Technology*  
Karlsruhe, Germany

Jürgen Teich  
*Universität Erlangen-Nürnberg*  
Erlangen, Germany

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Hochschule Zürich*  
Zurich, Sweden

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Kusatsu, Japan

Andres Torres  
*Mentor Graphics Corporation*  
Wilsonville, OR

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Richland, WA

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Storrs, CT

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Urbana, IL

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Chicago, IL

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Hopewell Junction, NY

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Austin, TX

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Yu Wang  
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Beijing, China

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San Diego, CA

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Portland, OR

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Santa Barbara, CA

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Beijing, China

Evangeline F.Y. Young  
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McKenzie Mortensen  
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Lata Valluri  
*Mentor Graphics Corporation.*  
Fremont, CA

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Mountain View, CA

Tim Whitfield  
*ARM Ltd.*  
Hsinchu, Taiwan

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*Futurewei Technologies, Inc.*  
Plano, TX

Michael Brogioli  
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Burlingame, CA

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Berkeley, CA

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Seattle, WA

Jan Rellermeyer  
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Austin, TX

Michael Solka  
*Coherent Logix*  
Austin, TX

Alicia Strang  
*Cadence Design Systems, Inc.*  
Irvine, CA

Colin Walls  
*Mentor Graphics Corporation.*  
Newbury, United Kingdom

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San Francisco, CA

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*Xpliant, Inc.*  
San Jose, CA

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Mountain View, CA

Aviv Barkai  
*Intel Corp.*  
Haifa, Israel

Suhas Belgal  
*Consultant*  
Los Gatos, CA

Jayendra Dwaraka Bhamidipatti  
*Intel Corp.*  
Bengaluru, India

Robert Carden IV  
*Marvell Semiconductor, Inc.*  
Aliso Viejo, CA

Lawrence Ching  
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El Segundo, CA

Dan Cohen  
*Google, Inc.*  
Mountain View, CA

Abdul Elaydi  
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Santa Clara, CA

Rajesh Goel  
*Qualcomm, Inc.*  
San Diego, CA

David Goldberg  
*Qualcomm Atheros, Inc.*  
San Jose, CA

Steve Grout  
*Consultant*  
Tampa, FL

Shankar Hemmady  
*Synopsys, Inc.*  
Mountain View, CA

Sushma Honnavara Prasad  
*Google, Inc.*  
Mountain View, CA

Jennifer Hwang  
*Quick Logic*  
Sunnyvale, CA

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Cambridge, United Kingdom

Carey Kloss  
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Milpitas, CA

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Austin, TX

Anshuman Nadkarni  
*NVIDIA*  
Cupertino, CA

Harsh Patel  
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San Francisco, CA

Wolfgang Roetzner  
*IBM Systems and Technology Group*  
Austin, TX

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Longmont, CO

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Hillsboro, OR

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Redmond, WA

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Santa Clara, CA

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Santa Clara, CA

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San Francisco, CA

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Chicago, IL

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Richardson, TX

Shan Yan  
*Broadcom Corp.*  
Irvine, CA

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*Cayenne Communication*  
Sunnyvale, CA

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San Jose, CA

Paul Cohen  
*EDA Consortium*  
San Jose, CA

John Day  
*Automotive Electronics*  
Kalamazoo, MI

Brian Fuller  
*Cadence Design Systems, Inc.*  
San Jose, CA

Joe Hupcey  
*Mentor Graphics Corporation.*  
San Jose, CA

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*S2C Inc.*  
San Jose, CA

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*Cadence Design Systems, Inc.*  
Austin, TX

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San Jose, CA

Ramesh Chandra  
*Qualcomm Technologies, Inc.*  
San Diego, CA

Mojo Chian  
*Silicon Cloud International Pte Ltd*  
Singapore, Singapore

Anne Cirkel  
*Mentor Graphics Corporation*  
Wilsonville, OR

Michelle Clancy  
*Cayenne Communication*  
Sunnyvale, CA

Craig Cochran  
*Cadence Design Systems, Inc.*  
San Jose, CA

Sri Ganta  
*Broadcom Corp.*  
San Jose, CA

Bob Gardner  
*EDA Consortium*  
San Jose, CA

Wolski Guntram  
*Cisco Systems, Inc.*  
San Jose, CA

Mahesh Iyer  
*Altera Corp.*  
San Jose, CA

Shankar Krishnamoorthy  
*Mentor Graphics Corporation*  
Wilsonville, OR

Michael "Mac" McNamara  
*Adapt IP*  
San Jose, CA

Aveek Sarkar  
*ANSYS, Inc.*  
San Jose, CA

Amir Salek  
*Google, Inc.*  
Mountain View, CA

Frank Schirrmeister  
*Cadence Design Systems, Inc.*  
San Jose, CA

Kurt Shuler  
*Arteris*  
Sunnyvale, CA

Tiffany Sparks  
*ARM, Inc./EDAC Rep*  
San Jose, CA

Yatin Trivedi  
*Mountain View, CA*  
San Jose, CA

Rob van Blommestein  
*S2C, Inc.*  
San Jose, CA